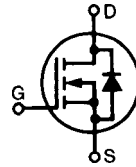


# MegaMOS™ FET

IXTH 35N30  
IXTH 40N30  
IXTM 40N30

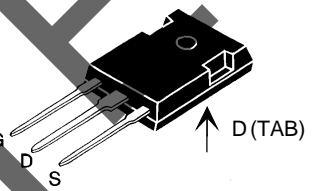
| $V_{DSS}$ | $I_{D25}$ | $R_{DS(on)}$   |
|-----------|-----------|----------------|
| 300 V     | 35 A      | 0.10 $\Omega$  |
| 300 V     | 40 A      | 0.085 $\Omega$ |
| 300 V     | 40 A      | 0.088 $\Omega$ |

## N-Channel Enhancement Mode

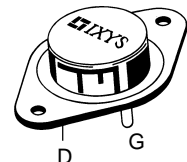


| Symbol        | Test Conditions   | Maximum Ratings             |                  |
|---------------|---|-----------------------------|------------------|
| $V_{DSS}$     | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$                                 | 300                         | V                |
| $V_{DGR}$     | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1\text{ M}\Omega$   | 300                         | V                |
| $V_{GS}$      | Continuous  | $\pm 20$                    | V                |
| $V_{GSM}$     | Transient   | $\pm 30$                    | V                |
| $I_{D25}$     | $T_C = 25^\circ\text{C}$  | 35N30: 35<br>40N30: 40      | A                |
| $I_{DM}$      | $T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$                      | 35N30: 140<br>40N30: 160    | A                |
| $P_D$         | $T_C = 25^\circ\text{C}$  | 300                         | W                |
| $T_J$         |   | -55 ... +150                | $^\circ\text{C}$ |
| $T_{JM}$      |   | 150                         | $^\circ\text{C}$ |
| $T_{stg}$     |   | -55 ... +150                | $^\circ\text{C}$ |
| $M_d$         | Mounting torque   | 1.13/10                     | Nm/lb.in.        |
| <b>Weight</b> |   | TO-204 = 18 g, TO-247 = 6 g |                  |
|               | Maximum lead temperature for soldering<br>1.6 mm (0.062 in.) from case for 10 s | 300                         | $^\circ\text{C}$ |

TO-247 AD (IXTH)



TO-204 AE (IXTM)



G = Gate, D = Drain,  
S = Source, TAB = Drain

### Features

- International standard packages
- Low  $R_{DS(on)}$  HDMOS™ process
- Rugged polysilicon gate cell structure
- Low package inductance (< 5 nH)
  - easy to drive and to protect
- Fast switching times

### Applications

- Switch-mode and resonant-mode power supplies
- Motor controls
- Uninterruptible Power Supplies (UPS)
- DC choppers

### Advantages

- Easy to mount with 1 screw (TO-247) (isolated mounting screw hole)
- Space savings
- High power density

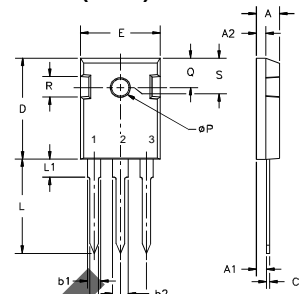
| Symbol       | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |  |
|--------------|---|---|------|--|
|              |   | min.  | typ. | max.   |
| $V_{DSS}$    | $V_{GS} = 0\text{ V}$ , $I_D = 250\ \mu\text{A}$                | 300   |      | V  |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 250\ \mu\text{A}$                    | 2   |      | V  |
| $I_{GSS}$    | $V_{GS} = \pm 20\text{ V}_{DC}$ , $V_{DS} = 0$                  |   |      | $\pm 100\text{ nA}$  |
| $I_{DSS}$    | $V_{DS} = 0.8 \cdot V_{DSS}$ , $V_{GS} = 0\text{ V}$            |   |      | 200 $\mu\text{A}$<br>1 mA  |
| $R_{DS(on)}$ | $V_{GS} = 10\text{ V}$ , $I_D = 0.5 I_{D25}$                    |   |      | IXTH35N30: 0.10 $\Omega$<br>IXTH40N30: 0.085 $\Omega$<br>IXTM40N30: 0.088 $\Omega$ |
|              | Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$ |   |      |  |

| Symbol       | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |      |    |
|--------------|---|---|------|------|----|
|              |   | min.  | typ. | max. |    |
| $g_{fs}$     | $V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$ , pulse test  | 22  | 25   | S    |    |
| $C_{iss}$    | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$   |   | 4600 | pF   |    |
| $C_{oss}$    |   |   | 650  | pF   |    |
| $C_{rss}$    |   |   | 240  | pF   |    |
| $t_{d(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 I_{D25}$<br>$R_G = 2\ \Omega$ , (External) |   | 24   | 30   | ns |
| $t_r$        |   |   | 40   | 90   | ns |
| $t_{d(off)}$ |   |   | 75   | 100  | ns |
| $t_f$        |   |   | 40   | 90   | ns |
| $Q_{g(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 I_{D25}$                                   |   | 190  | 220  | nC |
| $Q_{gs}$     |   |   | 28   | 50   | nC |
| $Q_{gd}$     |   |   | 85   | 105  | nC |
| $R_{thJC}$   |   |   | 0.42 | K/W  |    |
| $R_{thCK}$   |   |   | 0.25 | K/W  |    |

### Source-Drain Diode

| Symbol   | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |                |
|----------|---|---|------|----------------|
|          |   | min.  | typ. | max.           |
| $I_S$    | $V_{GS} = 0\text{ V}$   | 35N30<br>40N30  |      | 35 A<br>40 A   |
| $I_{SM}$ | Repetitive;<br>pulse width limited by $T_{JM}$  | 35N30<br>40N30  |      | 140 A<br>160 A |
| $V_{SD}$ | $I_F = I_S, V_{GS} = 0\text{ V}$ ,<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$ |   |      | 1.5 V          |
| $t_{rr}$ | $I_F = I_S, -di/dt = 100\text{ A}/\mu\text{s}, V_R = 100\text{ V}$                                    |   | 400  | ns             |

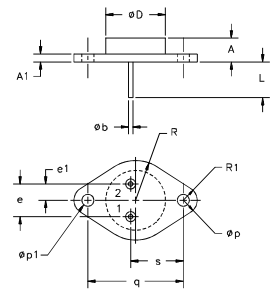
### TO-247 AD (IXTH) Outline



Terminals: 1 - Gate 2 - Drain  
3 - Source Tab - Drain

| Dim.           | Millimeter |       | Inches |       |
|----------------|------------|-------|--------|-------|
|                | Min.       | Max.  | Min.   | Max.  |
| A              | 4.7        | 5.3   | .185   | .209  |
| A <sub>1</sub> | 2.2        | 2.54  | .087   | .102  |
| A <sub>2</sub> | 2.2        | 2.6   | .059   | .098  |
| b              | 1.0        | 1.4   | .040   | .055  |
| b <sub>1</sub> | 1.65       | 2.13  | .065   | .084  |
| b <sub>2</sub> | 2.87       | 3.12  | .113   | .123  |
| C              | .4         | .8    | .016   | .031  |
| D              | 20.80      | 21.46 | .819   | .845  |
| E              | 15.75      | 16.26 | .610   | .640  |
| e              | 5.20       | 5.72  | 0.205  | 0.225 |
| L              | 19.81      | 20.32 | .780   | .800  |
| L1             |            | 4.50  |        | .177  |
| ∅P             | 3.55       | 3.65  | .140   | .144  |
| Q              | 5.89       | 6.40  | 0.232  | 0.252 |
| R              | 4.32       | 5.49  | .170   | .216  |
| S              | 6.15       | BSC   | 242    | BSC   |

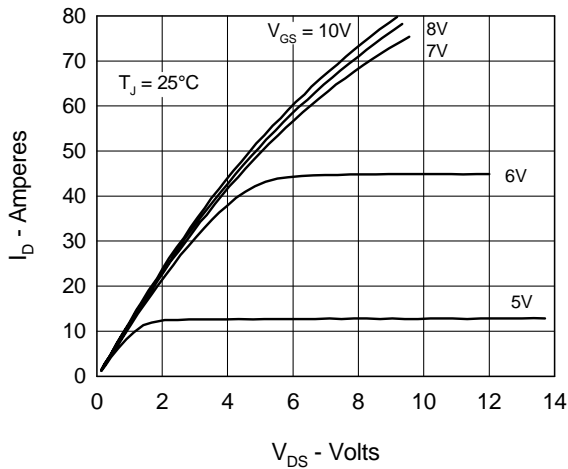
### TO-204AE (IXTM) Outline



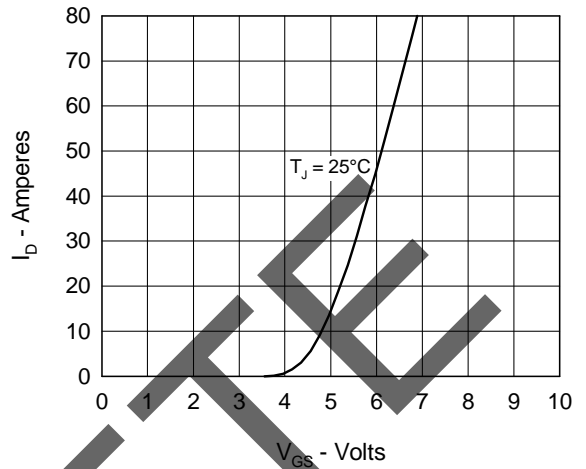
Pins 1 - Gate 2 - Source  
Case - Drain

| Dim.            | Millimeter |       | Inches |      |
|-----------------|------------|-------|--------|------|
|                 | Min.       | Max.  | Min.   | Max. |
| A               | 6.4        | 11.4  | .250   | .450 |
| A <sub>1</sub>  | 1.53       | 3.42  | .060   | .135 |
| ∅b              | 1.45       | 1.60  | .057   | .063 |
| ∅D              |            | 22.22 |        | .875 |
| e               | 10.67      | 11.17 | .420   | .440 |
| e <sub>1</sub>  | 5.21       | 5.71  | .205   | .225 |
| L               | 11.18      | 12.19 | .440   | .480 |
| ∅p              | 3.84       | 4.19  | .151   | .165 |
| ∅p <sub>1</sub> | 3.84       | 4.19  | .151   | .165 |
| q               | 30.15      | BSC   | 1.187  | BSC  |
| R               | 12.58      | 13.33 | .495   | .525 |
| R <sub>1</sub>  | 3.33       | 4.77  | .131   | .188 |
| s               | 16.64      | 17.14 | .655   | .675 |

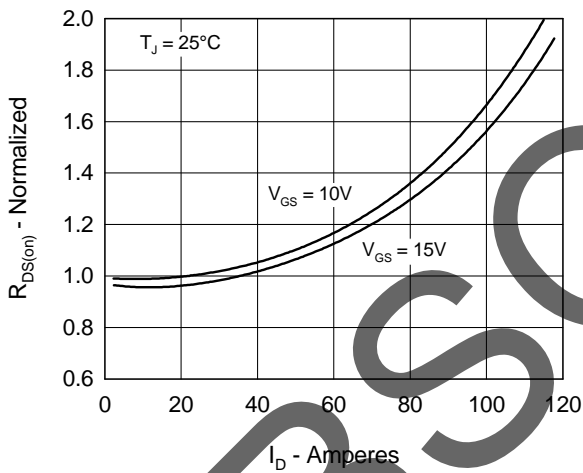
**Fig. 1 Output Characteristics**



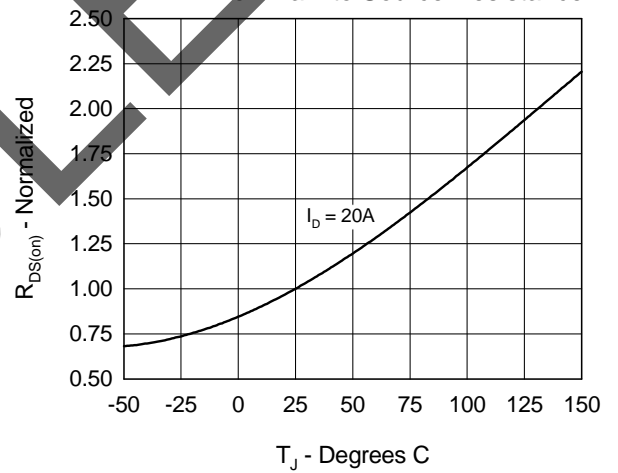
**Fig. 2 Input Admittance**



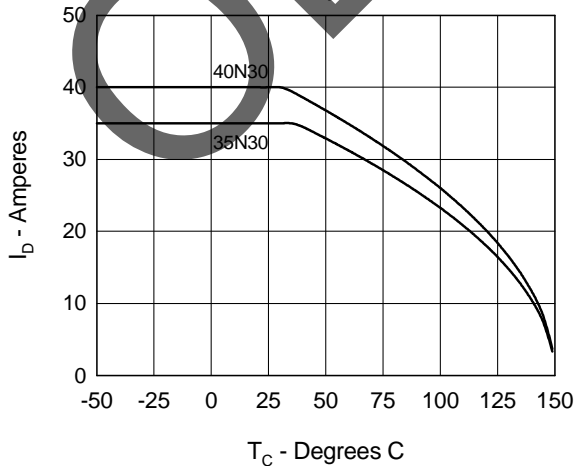
**Fig. 3  $R_{DS(on)}$  vs. Drain Current**



**Fig. 4 Temperature Dependence of Drain to Source Resistance**



**Fig. 5 Drain Current vs. Case Temperature**



**Fig. 6 Temperature Dependence of Breakdown and Threshold Voltage**

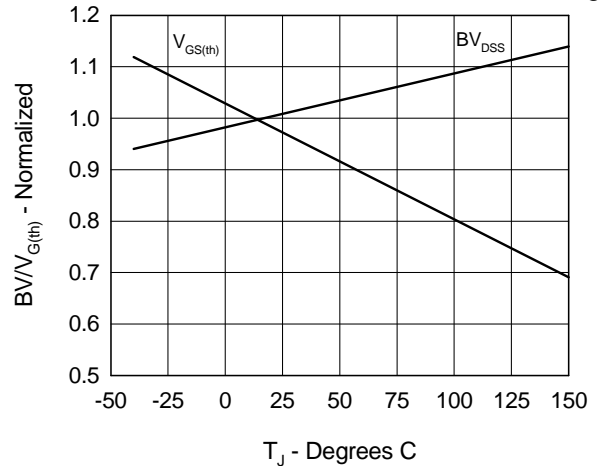


Fig.7 Gate Charge Characteristic Curve

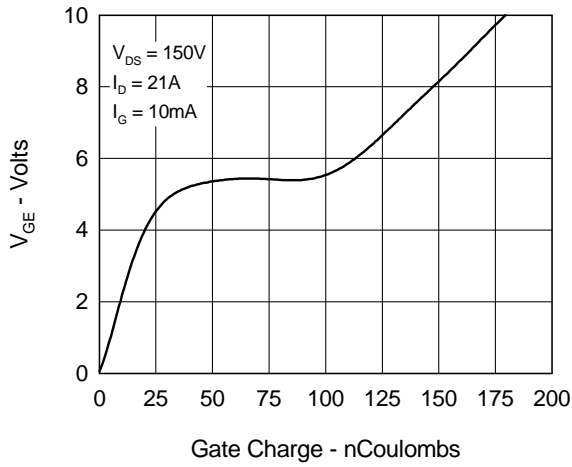


Fig.8 Forward Bias Safe Operating Area

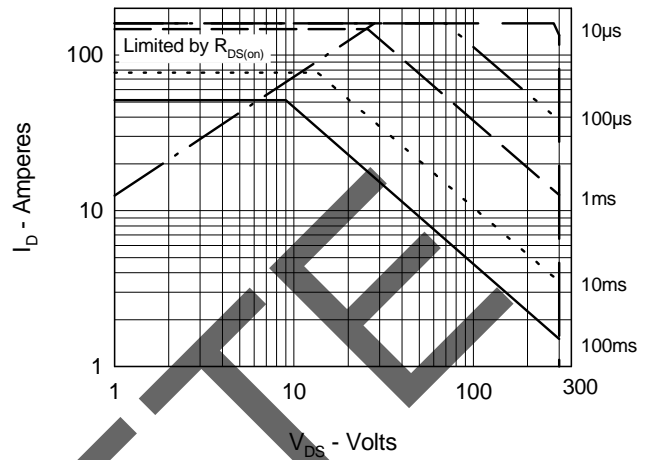


Fig.9 Capacitance Curves

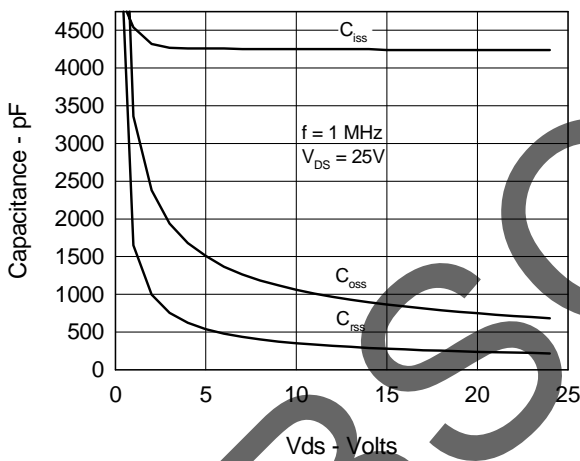


Fig.10 Source Current vs. Source to Drain Voltage

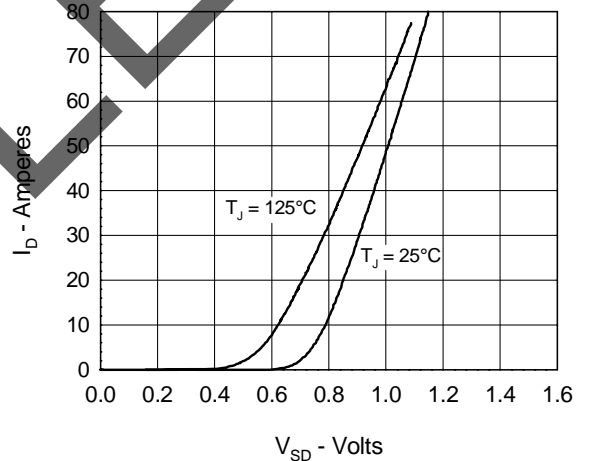
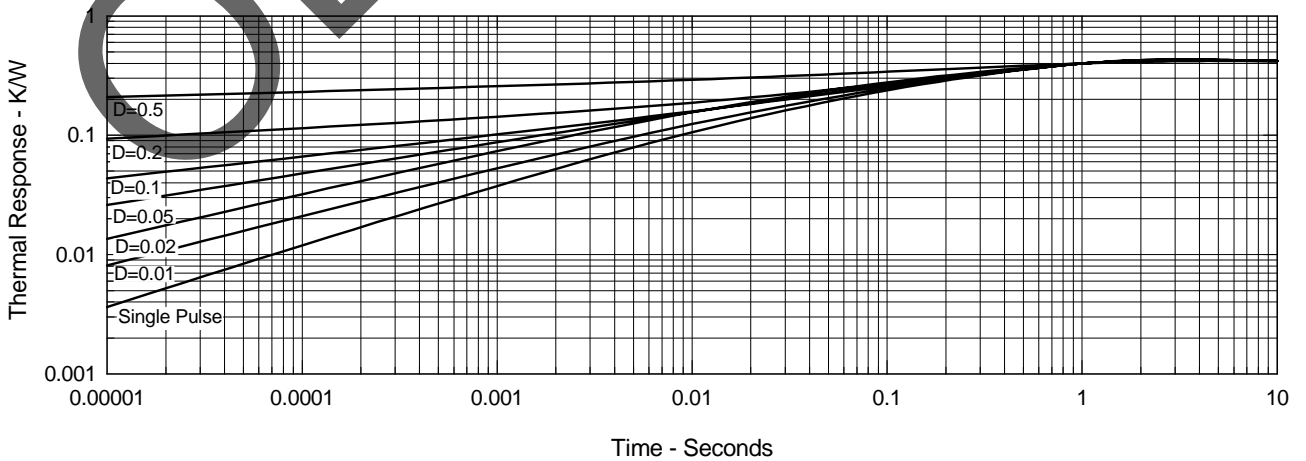


Fig.11 Transient Thermal Impedance





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